LCD Panel EMI Reduction IC

Product Description

The P3P2043B is a versatile spread spectrum frequency modulator designed specifically for digital flat panel applications. The P3P2043B reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of down stream clock and data dependent signals. The P3P2043B allows significant system cost savings by reducing the number of circuit board layers ferrite beads, shielding and other passive components that are traditionally required to pass EMI regulations.

The P3P2043B uses the most efficient and optimized modulation profile approved by the FCC and is implemented in a proprietary all digital method.

The P3P2043B modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation'.

Features

- FCC Approved Method of EMI Attenuation
- Provides Up to 15 dB of EMI Suppression
- Generates a Low EMI Spread Spectrum Clock of the Input Frequency
- Input Frequency Range: 30 MHz to 110 MHz
- Optimized for 32.5 MHz, 54 MHz, 65 MHz, 74 MHz and 108 MHz Pixel Clock Frequencies
- Internal Loop Filter Minimizes External Components and Board Space
- Eight Selectable High Spread Ranges Up to $\pm 2\%$
- SSON# Control Pin for Spread Spectrum Enable and Disable Options
- Low Cycle-to-Cycle Jitter
- $3.3 \text{ V} \pm 0.3 \text{ V}$ Operating Range
- Low power CMOS Design
- Supports Most Mobile Graphic Accelerator and LCD Timing Controller Specifications
- Available in 8-pin SOIC Package
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

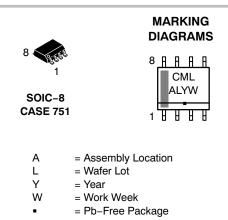
Applications

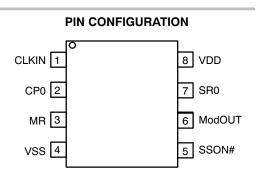
• The P3P2043B is targeted towards digital flat panel applications for notebook PCs, palm-size PCs, office automation equipments and LCD monitors.



ON Semiconductor®

http://onsemi.com





ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

P3P2043B

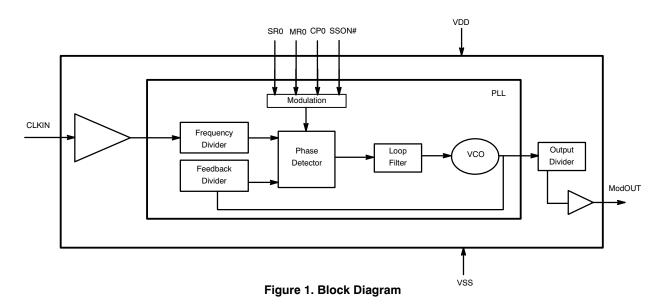


Table 1. PIN DESCRIPTION

Pin#	Pin Name	Туре	Description
1	CLKIN	Input	External reference frequency input. Connect to externally generated reference signal.
2	CP0	Input	Digital logic input used to select Spreading Range. This pin has an internal pull-up resistor. Refer Modulation Selection Table.
3	MR	Input	Digital logic input used to select two different Modulation Rate. This pin has an internal pull-up res- istor. Refer <i>Modulation Selection Table.</i>
4	VSS	Power	Ground to entire chip. Connect to system ground.
5	SSON#	Input	Digital logic input used to enable Spread Spectrum function (Active LOW). Spread Spectrum function enabled when LOW, disabled when HIGH. This pin has an internal pull-low resistor.
6	ModOUT	Output	Spread spectrum clock output.
7	SR0	Input	Digital logic input used to select Spreading Range. This pin has an internal pullup resistor. Refer <i>Modulation Selection Table.</i>
8	VDD	Power	Power supply for the entire chip

Table 2. MODULATION SELECTION

				Spre				
MR	CP0	SR0	32.5 MHz	54 MHz	65 MHz	81 MHz	108 MHz	Modulation Rate (kHz)
0	0	0	1.47	1.19	1.08	0.96	0.88	
0	0	1	2.26	1.82	1.66	1.48	1.31	(F (40) * 04 22
0	1	0	0.75	0.59	0.55	0.50	0.46	(F _{IN} / 40) * 94.33
0	1	1	3.03	2.43	2.20	1.98	1.74	
1	0	0	1.39	1.21	1.11	0.98	0.86	
1	0	1	2.06	1.85	1.67	1.47	1.27	(F (40) * 00.00
1	1	0	0.74	0.61	0.56	0.50	0.43	(F _{IN} / 40) * 62.89
1	1	1	2.88	2.49	2.26	2.00	1.71	

P3P2043B

Spread Spectrum Selection

The *Modulation Selection Table* defines the possible spread spectrum options. The optimal setting should minimize system EMI to the fullest without affecting system performance. The spreading is described as a percentage deviation of the center frequency. (Note: The center frequency is the frequency of the external reference input on CLKIN, pin1).

For example, P3P2043B is designed for high–resolution, flat panel applications and is able to support an XGA (1024 x 768) flat panel operating at 65 MHz (F_{IN}) clock speed. A spreading selection of CP0 = 0, CP1 = 1 and SR0 = 0 provides a percentage deviation of $\pm 1.00\%$ from F_{IN} . This results in the frequency on ModOUT being swept from 65.65 to 64.35 MHz at a modulation rate of 102.19 kHz. *Refer Modulation Selection Table*. The example in the following illustration is a common EMI reduction method for a notebook LCD panel and has already been implemented by most of the leading OEM and mobile graphic accelerator manufacturers.

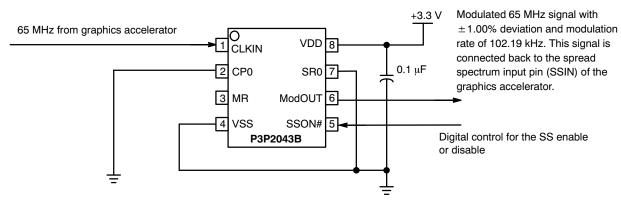


Figure 2. Application Schematic for Mobile LCD Graphics Controllers

Table 3	. ABSOLUTE	ΜΔΧΙΜΠΜ	RATING
Table J	ADSOLUTE		naima

Symbol	Parameter	Rating	Unit
V _{DD} , V _{IN}	Voltage on any input pin with respect to Ground	-0.5 to +4.6	V
T _{STG}	Storage temperature	-65 to +125	°C
T _A	Operating temperature	-40 to +85	°C
Ts	Max. Soldering Temperature (10 sec)	260	°C
TJ	Junction Temperature	150	°C
T _{DV}	Static Discharge Voltage (As per JEDEC STD22-A114-B)	2	kV

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. OPERATING CONDITIONS

Symbol	Parameter			Тур	Max	Unit
V _{DD}	Supply Voltage with respect to Ground			3.3	3.6	V
T _A	Operating temperature				+70	°C
TJ	Junction temperature (0°C to +70°C) SOIC				82.39	°C
θ _{JC}	SOIC			156.5		°C/W

Symbol	Parameter	Min	Тур	Мах	Unit
V _{IL}	Input low voltage	V _{SS} – 0.3		0.8	V
VIH	Input high voltage	2.0		V _{DD} + 0.3	V
۱ _{۱۲}	Input low current (pullup resistor on inputs CP0, CP1 and SR0)			-50	μΑ
I _{IH}	Input high current (pulldown resistor on input SSON#)			50	μΑ
V _{OL}	Output low voltage (I _{OL} = 8 mA)			0.4	V
V _{OH}	Output high voltage (I _{OH} = -8 mA)	2.5			V
I _{DD}	Static supply current (CLKIN pulled LOW)			300	μΑ
I _{CC}	Dynamic supply current (3.3 V and 10 pF loading)	6	15	22	mA
V _{DD}	Operating voltage	3.0	3.3	3.6	V
t _{ON}	Power-up time (first locked cycle after power up)			3	ms
Z _{OUT}	Clock output impedance		35		Ω

Table 5. DC ELECTRICAL CHARACTERISTICS

Table 6. AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter			Тур	Max	Unit
f _{IN}	Input Clock frequency			74	110	MHz
fout	Output Clock frequency	Output Clock frequency			110	MHz
t _{LH} *	Output rise time (measured between 20% to 80%)			1.5	2	ns
t _{HL} *	Output fall time (measured between 80% to 20%)			1.2	1.8	ns
t _{JC}	Jitter (cycle-to-cycle)	litter (cycle-to-cycle) < 50 MHz			±250	ps
	≥ 50 MHz				±200	
t _D	Output duty cycle		45	50	55	%

 $^{*}t_{LH}$ and t_{HL} are measured into a capacitive load of 10 pF.

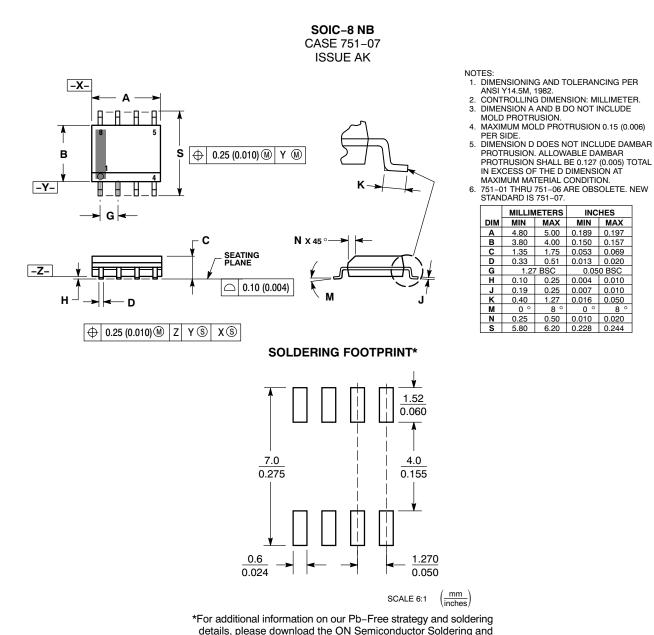
ORDERING INFORMATION

Part Number	Top Marking	Temperature	Package Type	Shipping [†]
P3P2043BG-08SR	CML	0°C to +70°C	SOIC-8 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb–Free.

P3P2043B

PACKAGE DIMENSIONS



Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and 💷 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights or the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for survailed in which the solut or other applications intended to survaice or sustain life or for any other applications intended to survaice the survaice in the solut or other applications intended to survaice the survaice in the solut or other applications intended to survaice the survaice in application is which the solut or other applications intended to survaice the survaice in the solut or other applications intended to survaice the survaice in the solut or other applications intended to survaice the survaice in the solut or other applications. surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

ON Semiconductor Website: www.onsemi.com

INCHES

MIN MAX 0.189 0.197

0.150 0.157

0.050 BSC

8

0.004 0.010

0 °

Order Literature: http://www.onsemi.com/orderlit For additional information, please contact your local

Sales Representative

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050